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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/620,285	07/14/2003	Robert C. Pack	CA7010492001	7734
23639	7590	09/10/2004	EXAMINER	
BINGHAM, MCCUTCHEN LLP THREE EMBARCADERO, SUITE 1800 SAN FRANCISCO, CA 94111-4067			TAT, BINH C	
			ART UNIT	PAPER NUMBER
			2825	

DATE MAILED: 09/10/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/620,285

Applicant(s)

PACK ET AL.

Examiner

Binh C. Tat

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 14 July 2003.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-36 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-36 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 15 December 2003 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
- ☐ Certified copies of the priority documents have been received.
 - ☐ Certified copies of the priority documents have been received in Application No. _____.
 - ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|---|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date <u>10/31/03, 06/29/04</u> . | 6) <input type="checkbox"/> Other: _____ |

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DETAILED ACTION

1. This office action is in response to application 10/620285 filed on 06/24/03.

Claims 1-36 remain pending in the application.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

2. Claims 1-36 are rejected under 35 U.S.C. 102(e) as being anticipated by Keogan et al. (U.S Patent 2004/0044984).
3. As to claims 1, and 22 Keogan et al. teach a method for writing a mask, comprising: generating integrated circuit design data (fig 5, fig 6, and 9 element 902 paragraph 0058 lines 1 to 5); and using information for interfeature relationships of the integrated circuit design data to write the mask (fig 5, fig 6 and 9 element 904 paragraph 0058 lines 5 to line 24).
4. As to claim 2, and 23 Keogan et al. teach wherein the interfeature relationships are on one layer of the integrated circuit design (see fig 4 element 404 paragraph 0042).
5. As to claim 3, and 24 Keogan et al. teach wherein the interfeature relationships are across multiple layers of the integrated circuit design (see fig 4 element 404 paragraph 0042).

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6. As to claim 4, and 25 Keogan et al. teach wherein the interfeature relationships comprise: interfeature process proximity effects; interfeature coupling across layers (see fig 4 element 404 paragraph 0042 and background); interfeature electronic relationships (see fig 4 element 404 paragraph 0042 and background); or wire interconnects longer than a given length (see fig 4 element 404 paragraph 0042 and background).
7. As to claim 5, and 26 Keogan et al. teach wherein using the information for interfeature relationships to write the mask further comprises: passing the information for interfeature relationships to a mask writing system mask (fig 5, fig 6 and 9 element 904 paragraph 0058 lines 5 to line 24).
8. As to claim 6, and 27 Keogan et al. teach a method for generating a lithography mask or a printed wafer, comprising: generating integrated circuit design data (fig 5, fig 6, and 9 element 902 paragraph 0058 lines 1 to 5); and using context information from the integrated circuit design data to write the mask or printed wafer (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056).
9. As to claim 7, and 28 Keogan et al. teach wherein using context information comprises: analyzing mask features for contextual priority (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056).
10. As to claim 8, and 29 Keogan et al. teach wherein using context information comprises: assigning priorities to the mask features (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056).
11. As to claim 9, and 30 Keogan et al. teach wherein assigning priorities to the mask features comprises: applying criteria to mask design data by manual process (fig 5, fig 6-

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9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and background).

12. As to claim 10, and 31 Keogan et al. teach wherein assigning priorities to the mask features comprises: applying criteria to mask design data by computer-aided automated process (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and background).

13. As to claim 11, and 32 Keogan et al. teach wherein using context information comprising: analyzing mask features to determine the circuit element expected to be produced by a lithography system at a chip wafer surface (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069 and background).

14. As to claim 12, and 33 Keogan et al. teach further comprising: configuring a mask design database to include additional contextual mask design data generated in using the contextual information from the integrated circuit design data (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069 and background).

15. As to claim 13, and 34 Keogan et al. teach further comprising: configuring the mask design database to optimize an order of mask design data for use by a mask writing system (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069 and background).

16. As to claim 14, and 35 Keogan et al. teach wherein using context information comprises: passing context information to a mask writing system (fig 5, fig 6 fig 7, fig 8

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and fig 9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069 and background).

17. As to claim 15, and 36 Keogan et al. teach wherein using context information comprises: controlling a mask writing system base on the context information (fig 5, fig 6 fig 7, fig 8 and fig 9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 00 69 and background).

18. As to claim 16, Keogan et al. teach an apparatus for mask writing comprising: means for generating a design of an integrated circuit design (fig 5, fig 6, and 9 element 902 paragraph 0058 lines 1 to 5); means for producing circuit contextual information for the integrated circuit design (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069); means for capturing the circuit contextual information in a mask design database (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069); mean for producing mask contextual information for mask elements in the mask design database based on the circuit contexmal information (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069); means for configuring the mask design database to reflect the mask contextual information; and means for writing the mask elements on a mask substrate (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069).

19. As to claim 17, Keogan et al. teach wherein said means for writing further comprises: means for determining manufacturing enhancements for one or more mask elements based on the mask contextual information; and means for applying the

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manufacturing enhancement to the mask element (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069 and background).

20. As to claim 18, Keogan et al. teach further comprising: means for producing priority information for the mask elements based on features of the ask elements (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069 and background).

21. As to claim 19, Keogan et al. teach a method for mask writing, comprising: designing an integrated circuit (fig 5, fig 6, and 9 element 902 paragraph 0058 lines 1 to 5); passing the design data to a context and priority analysis step (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069); analyzing design data for each mask element to determine a circuit function, circuit criticality context, and priority for each mask element (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069); including the circuit function, circuit criticality context, and priority data in a mask design data file (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069); and using the mask design data file to write a mask (fig 5, fig 6-9 element 904 paragraph 0058 lines 5 to line 24 and paragraph 0049 to paragraph 0056 and paragraph 0069).

22. As to claim 20, Keogan et al. teach wherein design data from the integrated circuit design comprises: polygonal shape, location, layout geography, circuit functionality and circuit criticality data for each mask element (see fig 11 and 12 paragraph 0064 to 0069).

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23. As to claim 21, Keogan et al. teach wherein analyzing further comprises:
comparing design data for each mask element to design data for other mask elements and
to a predetermined set of mask criteria (see fig 11 and 12 paragraph 0064 to 0069).

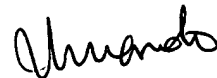
Conclusion

24. Any inquiry concerning this communication or earlier communications from the
examiner should be directed to Binh C. Tat whose telephone number is (571) 272-1908.
The examiner can normally be reached on 7:30 - 4:00 (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's
supervisor, Mathew Smith can be reached on (571) 272-1907. The fax phone numbers
for the organization where this application or proceeding is assigned are (571) 273-1908
for regular communications and (703) 305-3431 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or
proceeding should be directed to the receptionist whose telephone number is (703) 308-
1782.

Binh Tat
Art unit 2825
September 4, 2004



THUAN DO
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